

## Product Feature

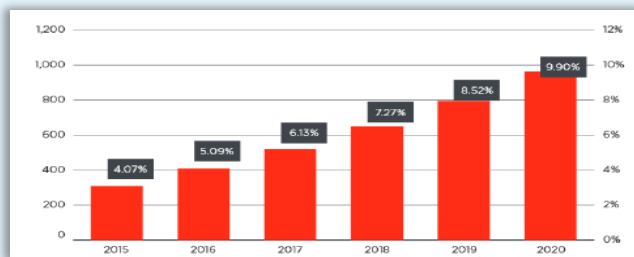
- ❑ High performance with low power/ Multimode / MCU
- ❑ Widely application/ Primary market
- ❑ Cost down with high market competitive advantage

## Company Strength

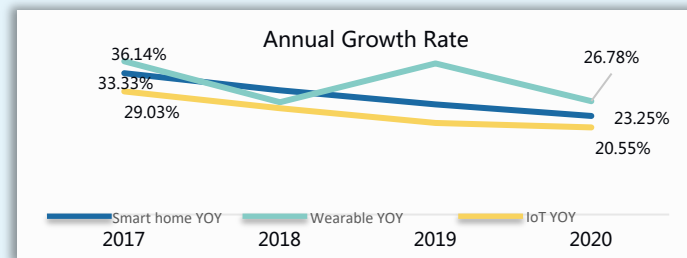
- ❑ Senior Technical and Management Team worked at Broadcom with extensive experience in wireless communication
- ❑ One Global team



# Market Growth



Large scale—IOT market extensive , growing rapidly  
 Widely application—market keep growth YOY20%-35% )



**To integrate fragmented requirements in IoT market  
 Creating more application scenarios**



2.4GHz  
 ( WiFi/BLE)

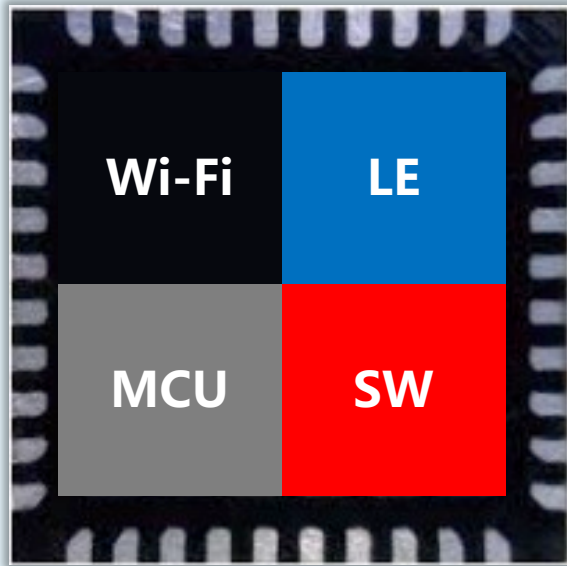


SUB-GHz  
 ( NB-IOT )



# Product positioning and introduction

Excellent performance——OPL1000/ OPL2500 : 2.4GHz Wi-Fi/LE SoC Product



Single SoC w/ multiple wireless protocols

Ultra low power and latency

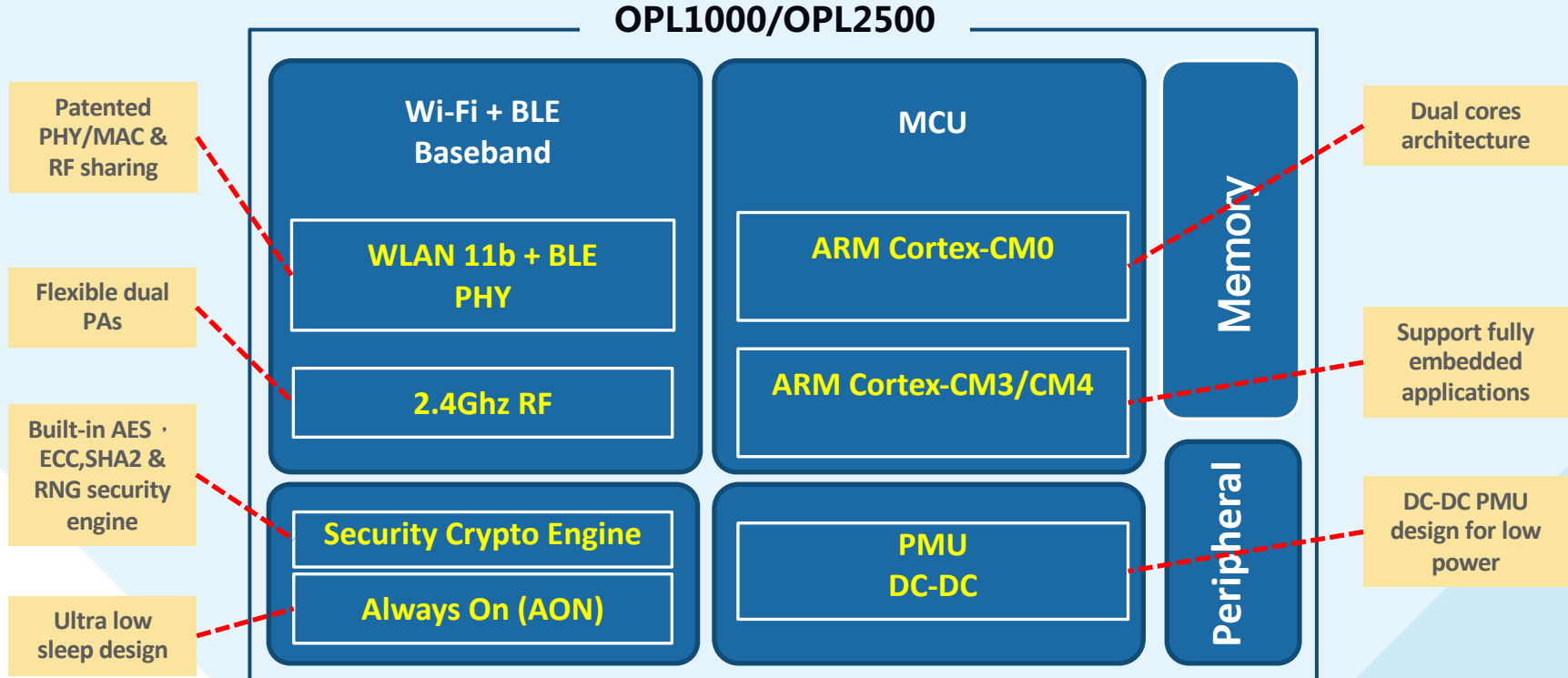
Fully embedded architecture

Dual MCUs and flexible memory

High Integration/Low System Cost

# Product positioning and introduction

Excellent performance — Shared WiFi/LE Architecture+Ultra Low Power+Highly Integrated Chip  
Includes Power Management, Power Amplifier, Crypto Engine



# Competition Analysis—Main Competition

## ■ COMBO & WiFi only & LE only comparison :

Product	COMBO ( WiFi+LE )		WiFi only		LE only	
Chip	<b>OPL1000</b>	Espressif ESP32	Microchip RN1732	MediaTek MT7681	Dialog DA14580	Telink TLSR8269
Features	<b>WiFi 11b+LE</b>	WiFi 11b/g/n+LE	WiFi 11b/g/n	WiFi 11b/g/n	LE	LE
Sleep (uA)	<b>~2</b>	25	4	1100	0.6	1.7
Rx (mA)	<b>Wi-Fi: ~18</b>	Wi-Fi: 85 LE: not released	40	151	4.9	12
Tx (mA)	<b>Wi-Fi: ~20 (0dBm)</b>	Wi-Fi: <225 (0dBm) LE: not released	120 (0dBm)	242 (19dBm)	4.9	15
Tx Output Pw (dBm)	<b>Wi-Fi: 0-15 LE: 0-10</b>	Wi-Fi: 20.5 LE: 0-4	0-12	19	0	0-7
Rx Sensitivity (dBm)	<b>Wi-Fi: -92(11b)</b>	Wi-Fi: -98(11b) LE: -98	-83 (typ)	Wi-Fi: -91 (11b)	-93	-92
Dimension (mm2)	<b>~9.5</b>	8.5 (40nm)	26.5	~10	6	~7

# Competition Analysis—Main Competition

## In line with the trend of the industry, leading in performance and cost

- Product advantages — highly integrated SoC with MCUs, PMU, Security, multiple wireless standards in the system (WiFi + LE), ultra low power consumption, very low cost
- Wide range of applications — ultra low power, combo WiFi/LE with dual cores architecture will create more IoT connections, radically changes the wireless connectivity design of the IoT
- Competitor — main competitor of combo/low-cost chip is Espressif where they are based on licensed IPs
- Power consumption — OPL1000 vs. ESP32 1:5 difference
- Cost leadership — Both cost and ASP are lower than ESP32
- Technological Leadership/Market — Ultra low power consumption, own wireless IPs, focus on low power applications first but not limited to all other applications, able to support all IoT applications

# Market - Key Selling Point KSP

- Main focus area : Smart lock, Smart Scale, Wi-Fi positioning, Healthcare, Smart Lighting and Switch, Transparent mode

## Smart Lock

- Battery Powered very sensitive to power
- Direct cloud connection without gateway



## Smart Scale

- Battery Powered very sensitive to power



## WiFi Location

- Battery Powered very sensitive to power



## Personal Health Care

- Battery Powered very sensitive to power



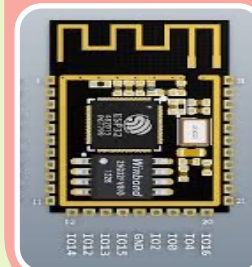
## Lighting & Switch

- Energy Star 0.2W (going to be 0.1W)
- Solving the ghost flare issue with single hot wire



## Transparent mode

- Quick replacement of ESP8266 or ESP32 (competitors)



# Other application markets

Remote control  
-----  
BLE+WiFi Remote Control  
(Voice /OTA)



Watch & Band  
-----  
Hybrid BLE/WiFi watch, Fitness Band



Toys  
-----  
Battery powered Remote control/voice



Smart Speaker  
-----  
BLE+WiFi  
Battery powered sensitive to power consumption



Fish Eye  
-----  
Battery powered sensitive to power consumption



AIoT  
-----  
AI Voice+IoT  
AI Image+IoT





# Company Direction

## IoT Trend – Build solid shared-architecture

- ARM CM3/CM4 -> RISC V
- +WiFi 6 AX STA
- +BLE 5.X
- +NB-IoT (Multi-mode)

